

# DRD1100G22

# **Rectifier Diode**

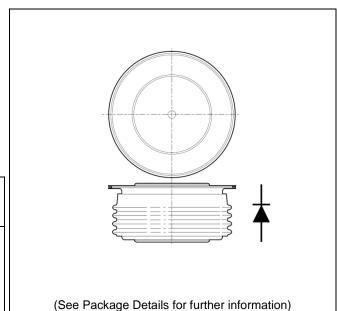
DS5999-1 March 2011 (LN28185)

## **FEATURES**

- Double Side Cooling
- High Surge Capability

## **KEY PARAMETERS**

$V_{RRM}$	2200V
I <sub>F(AV)</sub>	1100A
I <sub>FSM</sub>	13900A



VOLTAGE RATINGS

Part and Ordering Number	Repetitive Peak Voltages V <sub>RRM</sub> V	Conditions
DRD1100G22 DRD1100G20 DRD1100G18 DRD1100G16	2200 2000 1800 1600	$V_{RSM} = V_{RRM} + 100V$

Fig. 1 Package outline

# **ORDERING INFORMATION**

When ordering, select the required part number shown in the Voltage Ratings selection table.

For example:

**DRD1100G22** for a 2200V device

# **CURRENT RATINGS**

## $T_{\text{case}}$ = 75°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units		
Double Si	Double Side Cooled					
I <sub>F(AV)</sub>	Mean forward current	Half wave resistive load	1330	А		
I <sub>F(RMS)</sub>	RMS value	-	2090	А		
I <sub>F</sub>	Continuous (direct) on-state current	-	1880	Α		

## $T_{\text{case}}$ = 100°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units		
Double Si	Double Side Cooled					
I <sub>F(AV)</sub>	Mean forward current	Half wave resistive load	1100	Α		
I <sub>F(RMS)</sub>	RMS value	-	1720	А		
I <sub>F</sub>	Continuous (direct) on-state current	-	1560	Α		

# **SURGE RATINGS**

Symbol	Parameter Test Conditions		Max.	Units
I <sub>FSM</sub>	Surge (non-repetitive) on-state current	10ms half sine, T <sub>case</sub> = 175°C	13.9	kA
l <sup>2</sup> t	I <sup>2</sup> t for fusing	$V_R = 0$	0.97	MA <sup>2</sup> s

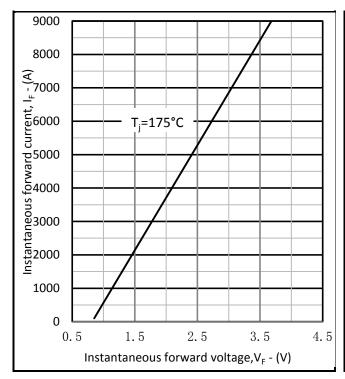
# THERMAL AND MECHANICAL RATINGS

Symbol	Parameter	Test Conditions		Min.	Max.	Units
R <sub>th(j-c)</sub>	Thermal resistance – junction to case	Double side cooled	DC	-	0.035	°C/W
R <sub>th(c-h)</sub>	Thermal resistance – case to heatsink	Double side cooled	DC	-	0.008	°C/W
T <sub>vj</sub>	Virtual junction temperature	Blocking V <sub>DRM</sub> / <sub>VRRM</sub>		-40	175	°C
T <sub>stg</sub>	Storage temperature range			-40	175	°C
F <sub>m</sub>	Clamping force			12	18	kN

## **CHARACTERISTICS**

Symbol	Parameter	Test Conditions	Min.	Max.	Units
V <sub>FM</sub>	Forward voltage	At 1500A peak, T <sub>case</sub> = 25°C	-	1.45	V
I <sub>RM</sub>	Peak reverse current	At V <sub>DRM</sub> , T <sub>case</sub> = 175°C	-	60	mA
Q <sub>S</sub>	Total stored charge	$I_F = 1000A$ , $dI_{RR}/dt = 10A/\mu s$ $T_{case} = 175^{\circ}C$ , $V_R = 100V$	-	2500	μC
V <sub>TO</sub>	Threshold voltage	At T <sub>vj</sub> = 175°C	-	0.82	V
r <sub>T</sub>	Slope resistance	At T <sub>vj</sub> = 175°C	-	0.318	mΩ

# **CURVES**



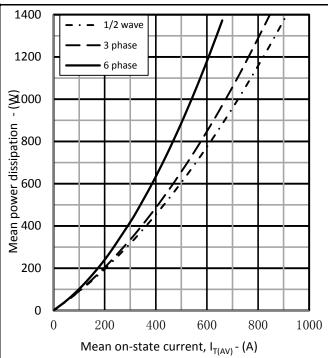
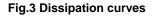


Fig.2 Maximum forward characteristics



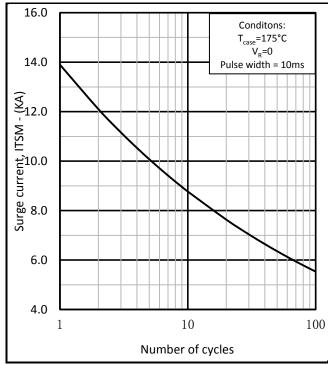


Fig.4 Surge (Non-Repetitive) Forward current vs time

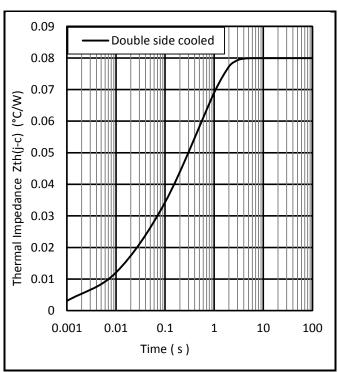
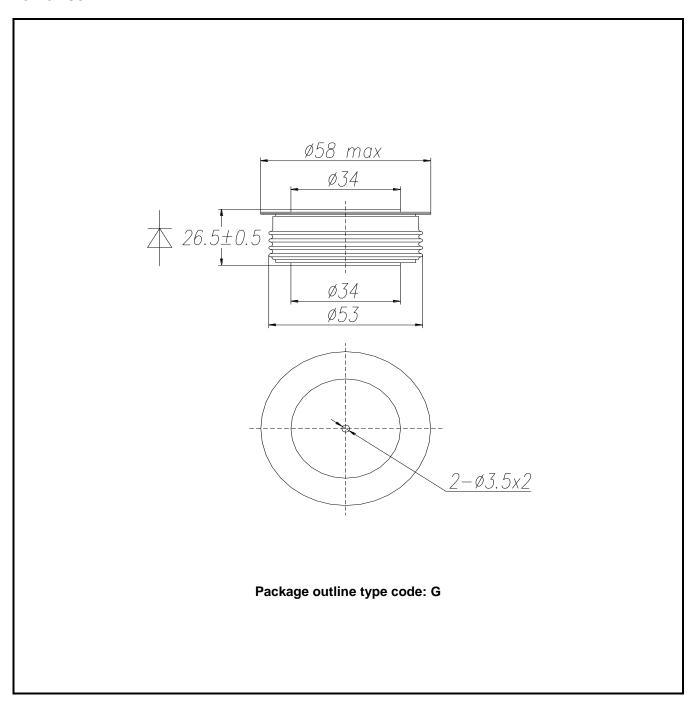


Fig.5 Maximum (limit) transient thermal impedancejunction to case

## **PACKAGE DETAILS**

For further package information, please contact Customer Services. All dimensions in mm, unless stated otherwise. DO NOT SCALE.



#### Note:

Some packages may be supplied with gate and or tags.

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